

TIDA-00492 Assembly Bill of Materials

Texas Instruments

Project Name:	TIDA-00492 - Staple Detection
Project File:	Staple_detector.PrjPCB
Base ID:	TIDA-00492
Schematic Rev:	E1
Assembly Variant:	None
Build Quantity:	1
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Item	Designator	Description	RoHS	Manufacturer	PartNumber	Quantity	Required	Supplier 1	Supplier Part Number 1	Supplier 2	Supplier Part Number 2	Alternate Manufacturer	Alternate PartNumber
1	PCB	Printed Circuit Board	O	Any	TIDA-00492	1	1						
2	C1	CAP, CERM, 4700pF, 50V, +/-10%, X7R, 0402	Y	MuRata	GRM155R71H472KA01J	1	1	Digi-Key	490-8259-1-ND				
3	J1	Header, TH, 100mil, 2x1, Gold plated, 230 mil above insulator	Y	Samtec	TSW-102-07-G-S	1	1	Digi-Key	SAM1029-02-ND				

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